DISTAX >>>

Built-In Laser Interferometer with Optical Fiber Coupling

DISTAX 300A



Features

Max. count

No. of axes

Data output delay time

- High speed and high function system for measuring a maximum of three axes.
- Various interference optical heads are available for a wide range of measuring items.
- Host of programs for a variety of machine tool inspection standards can be executed on an external personal computer.
 Complete CNC automation of following processes: Measurement → Compensation → Inspection → Report.



Traditional approach: Three points must be arranged in a straight line. This requires considerable skill and experience.



DISTAX connects the laser source and the interference head using an optical fiber cable. Setup can be performed by simply aligning the interference head and the reflection mirror in a straight line.

- Utilizes stable-frequency high-precision He-Ne laser as the light source.
- Optical axis alignment can be performed by simply arranging the interference head and reflector in a straight line. This efficient process dramatically reduces man-hours.
- Board type counter can be incorporated into a PCI bus.

Specifications							
●System							
Model	300A						
Max. measuring length	Corner cube type: 10m, Plane mirror type: 5m						
Optical fiber length	Select 3m, 5m or 10m						
Resolution	Corner cube type: 5nm, Plane mirror type: 2.5nm						
Max. response speed	Corner cube type: 630mm/s,						
	Plane mirror type: 315mm/s						
Accuracy	\pm (L × 10 ⁻⁷ + 0.01 × 10 ⁻⁶) m L = Measuring length (m)						
No. of axes	Max. 3						
Counter Board							
Max. response frequency	/ 2.0 MHz						
Reflection mirror movement speed	Single path interference head: Approx. 630 mm/sec. (interference signal wavelength input/2 o'clock) Double path interference head: Approx. 315 mm/sec. (interference signal wavelength input/4 o'clock) Refer to measurement specifications for the reflection mirror						

movement speed

1 axes/1 board

± 2³³-1

Max. 1µs

Laser Head Specifications					
Light source	Stabilized wavelength single mode He-Ne laser				
Light output	Approx. 0.3 mw (for 1 axis)				
Wavelength stability	± 1 x 10 ⁻⁷				
Number of optical axes	3				
Warm-up time	Approx. 10 minutes				
Input voltage	Single phase AC 100 V \pm 10%				
(Unit PS-300A power	Frequency 50/60 Hz				
used)	3-pin AC plug				
Power consumption	90 VA				
Main dimensions	$160(W) \times 455(D) \times 116(H)$ mm 7.5kg				
Usage environment	Temperature: 10°C – 40°C				
	(Temperature change during usage $\pm 10^{\circ}$ C)				
	Humidity: 10 – 90% (no condensation)				



DISTAX >>>

CNC Fully Automatic Measuring Systems

DISTAX Manager

- Inspection system used in combination with the DISTAX 300A system to significantly reduce the number of inspection man-hours on NC machine tools.
- Continuous automatic measurement of X, Y and Z axes can be performed after one setup operation (maximum of three machine tools for total of 9 axes). In addition, transmission of correction data (pitch error, backlash, etc) and output of inspection results are fully automated.







• ISO standard measurement programs fully comply with ISO 230-2. These programs handle average deviation of stop positions in one



The adoption of optical fiber eliminates cosign error due to inclination of the head. This enables consistently high precision measurements. Setup is extremely easy and can be completed in a short amount of time since alignment of the optical axis can be performed by simply arranging the interference head and reflector in a straight line.

In addition to 3-axis automatic measurement, the unit can be used to simultaneously or sequentially control three NC units. This high processing capability dramatically boosts the efficiency of adjustment and inspection processes.

High Efficiency

Alignment of the DISTAX is extremely easy, and the interference head can be built into the machine, eliminating the necessity of troublesome setup with a tripod.

The DISTAX Manager is a fully automatic system capable of continuous automatic calibration and inspection of the X, Y and Z axes with one setup operation.

Fully automatic operation of the system can be performed at night. Backlash compensation and NC pitch error compensation are performed when measurement is completed. This data can be used for immediate automatic output of an inspection report that complies with ISO standards.

Specifications	DISTAX Manager Software			
Number of measuring points	Max. 3 axes; 3 NC units simultaneously or sequentially			
Types of NC units	Compliant with FANUC 16, 18 or 21			
Measurement/ output data	Fully compliant with ISO 230-2 standard 14 positioning accuracy inspection items, including average reversing error Various graph outputs Output of formatted inspection reports			
Correction	Measurement of NC pitch error and correction of NC backlash			

Distance (JIS, ISO) / Speed / Dynamic Measurements

Resolution: $0.005 \,\mu$ m ($0.0025 \,\mu$ m) Measuring accuracy: ± 0.1 ppm Measuring range: 10m/axis (5m/axis) Values in parentheses for plain mirror.



Pitching/Yawing/Two-Point Links Straightness/Flatness Measurement

Resolution: 0.05 sec. (0.015 sec.) Measuring distance: 5m Measuring accuracy: ±0.2% (±0.6%) Measuring range: ±10° (0.5mm) Values in parentheses for flatness measurement.





Straightness / Squareness Measurements

Resolution: $0.05 \,\mu$ m Measuring distance: 3m (1m) Measuring accuracy: $0.4 \,\mu$ m/m (±0.5 sec.) Measuring range: ±1.5mm (±0.08°) Values in parentheses for squareness measurement.





der) Corner cube dual type Square kit (Penta-prism, bender, large corner cube) ACCRETECH TOKYO SEIMITSU

Measuring

item

Interterence heads

Reflectors

LAZAX >>>

Laser Interference Measuring Sensor

LAZAX



Features

High Resolution

LAZAX achieves a high resolution of 0.01 $\,\mu\,m$ for long displacement measurements (30 mm) not possible with conventional non-contact displacement sensors.

Sensitivity Calibration Unnecessary

Precise control of the semiconductor laser temperature enables high-precision measurements that are not influenced by temperature changes.

High Stability and Precision

The adoption of a Fizeau type interference optical system and heterodyne interference provide high stability and precision.

Super Compact Probe

The tip of the detection probe has a very small diameter of 3.8 mm, making it ideal for incorporation in compact high-precision XY table positioning detectors and other such units.

Host of Functions

The unit comes with a host of functions, including smoothing (6 types), display resolution changeover, mm/inch changeover, object light intensity level display, error display and external output.

Specifications								
Main Specifications			Display Unit					
Model	L-DD-01			Display	8 digit blue fluorescent display tube			
Accuracy	±0.1 μm			Min. display value	0.00001 mm (0.000001 inch)			
Max. response speed	15 mm/s			Output (measured data)	24-bit straight binary			
Laser wavelength used	Approx. 67	70 nm		External operation	Zero set, output latch			
Resolution	0.01 μm			Functions	Detection signal level display, error pattern display,			
Max. measuring length	Max. measuring length 30 mm				smoothing, mm/inch changeover, min. display changeover			
Detection Prote		,		(0.01, 0.1, 1, 10 μm)				
		1	Dimensions	$278(W) \times 300(D) \times 71(H) \text{ mm}$				
Laser light output from probe tip		1 mw or less		Weight	3 kg			
External dimensions		ϕ 3.8 × 30 mm (tip)		U				
Min. distance from probe tip to measured surface		20 mm						
Max. distance from probe tip to measured surface		50 mm						
Beam spot diameter of measured surface		Approx. 0.4 mm		Power source	AC 85 – 250 V, 50/60 Hz, 30 VA			
Optical fiber cable length		3 m		Usage temperature	$23^{\circ}C \pm 5^{\circ}C$ (Storage temperature: 0 – 50°C)			
Weight		30 g		Options	Analog output, probe fixture with gate mechanism			





High Resolution Positioning

The unit can be used to perform high-resolution positioning on a precision stage.



Laser Light

Safety precautions have been implemented on this unit in accordance with JIS standards. The amount of output is low, but make sure to follow the instructions on the label to prevent injury.



Explanation of Principle

Frequency modulated semiconductor laser light is transmitted to the optical fiber cable through the optical fiber coupler, and converted into parallel light by the lens at the tip of the detector probe. The reflection light from the probe performs heterodyne interference with the object light from the measuring surface as reference light, and goes through the detection probe and optical fiber coupler and is detected by the light-receiving element.



Outer Appearance/Dimension Diagram



ZACCRETECH TOKYO SEIMITSU

CADICOM >>>

Non-Contact Detection of Conductor/Semiconductor Displacement

CADICOM

Capacitance Type Displacement Sensor



Non-Contact Type

The object being measured is not subjected any load since no contact is made, and is free from influence of the vibration mode or rotation.

Extensive Range of Materials

The unit can be used to detect displacement in a wide range of conductors and semiconductors, regardless of the type of material.

Detection Principle

When a potential is applied with two electrodes facing one another as shown in Fig. 1, an electric charge builds up between the electrodes. This is defined as C = qV where the electric charge is q, the voltage is V and the capacitance is C.

The capacitance (C) is a function of the surface of the opposing electrodes (S) and distance between the electrodes (D).

This is expressed by C = $\epsilon\,$ \times S/D where $\,\epsilon\,$ is the dielectric constant of the air.

The capacitance (C) is in inverse proportion to the distance between the electrodes as long as the dielectric constant ε and electrode surface (S) remain constant. Therefore, the distance (D) can be measured if the voltage which is proportionate to the capacitance (C) can be detected. On a practical level, an electrode called a guard ring is provided around the measuring electrodes to stabilize measurements with the sensor as shown in Fig. 2. Since output from the sensor is not linear, a linearizing circuit is provided to enhance linearity.

Wide Response Frequency

The unit has a wide response frequency, enabling measurement of various types of displacement, from static displacement to high-speed moving bodies.

Compact Probe

The probe is compact and the electrode is completely sealed.





Non-Contact Wafer Thickness Measurement

Non-contact wafer thickness measurement is performed after the mask process.



Wafer Flatness Measurement

Automatic processing of wafer flatness is performed by using 13



Hard Disk Surface Run-Out Measurement

Run-out and eccentricity can be measured without making any contact.





VTR Head Run-Out Measurement

Rotational run-out of VTR heads and leads are measured.



Outer Appearance/Dimension Diagram



Specifications

•							
Model Amplifier unit Sensor head		E-CA-01					
		E-DT-CA21A		E-DT-CA24A		E-DT-CA26A	
Sensor head shape		ϕ 3 spherical surface		ϕ 10 spherical surface		ϕ 40 spherical surface	
		ϕ 8 mount	ϕ 8 mount ϕ 10 mount				
Main amplifier dimer	nsions	$110(W) \times 51(H) \times 181(D)$ (Max. dimensions including rubber feet and sensor connector)					
Measuring length		0.01 – 0.1 mm	0.1 – 1 mm			0.5 – 5 mm	
Analog output	Response frequency			4 kHz (–3dB)			
	Linearity			± 0.5% F.S.			
	Output voltage	+0.5 - +5V		+0.5 - +5V		+0.5 - +5V	
	Resolution			0.2 % F.S. *1			
Temperature	Amplifier unit			0.1 % F.S. / °C			
characteristics	Sensor head	0.1 % F.S. / °C		0.05 % F.S. / °C		0.05 % F.S. / °C	
Power source	Voltage	DC 24 V \pm 10%, Allowable ripple: 10% p-p or less					
	Consumption	200 mA or less					
Usage ambient Amplifier unit		0 − 40°C					
temperature	Sensor head	0−40°C					
Usage ambient	Amplifier unit	35 – 80 % R.H. (no condensation)					
humidity	Sensor head	35 – 80 % R.H. (no condensation)					
Display LED		Power (PWR: Yellow), Detection distance (20, 40, 60, 80, 100%: Green, Over: Red)					
Ambient atmosphere)	Be careful that water, oil or other contaminants do not get on the sensor head.					
Sensor cable length		3m					
Weight Amplifier unit		Approx. 680 g					
	Sensor head (including cable)	Approx. 115 g		Approx. 105 g		Approx. 260 g	
*: Above specifications are f *: % F.S. is percentage of m	or when the item measured is th easuring length upper limit value	e standard specimen. 9.	r	Power Unit			
 Temperature characteristics are value for 100 % F.S. Excluding switching noise (Frequency component 250 kF) 		Iz or higher)		Model		E-DL-02	
				Power source	AC100	V	
				Dimensions 110 (W) × 150 (D) >		V) × 150 (D) × 45 (H) mm	

Usage Guidelines

- This unit cannot be used in a location where there is water, oil, chips or other foreign matter.
- The amplifier unit and sensor head units are adjusted in a one-to-one configuration. The precision cannot be guaranteed if this configuration is changed.
- Mount the sensor head unit so that the measuring surface is parallel with the surface to be measured.
- Use the unit in a location that has a minimum of ambient temperature fluctuation.
- Avoid subjecting the sensor head unit to shock or undue force. Take precautions to ensure that the sensor head unit is not scratched.
- The measuring sensitivity and linearity differ depending upon the material that is measured. The amplifier unit must be adjusted for each type of metal.



EDYCOM >>>

Non-Contact Detection of Metal Displacement



Eddy-Current Type Displacement Sensor



Non-Contact Type

The object being measured is not subjected any load since no contact is made, and is free from influence of the vibration mode or rotation.

Wide Response Frequency

The unit has a wide response frequency, enabling measurement of various types of displacement, from static displacement to high-speed moving bodies. A circuit is used to enhance linearity.

Linear Output

Output is converted into a voltage proportionate to the displacement by a linearizing function, simplifying monitoring, control, recording and data analysis.

Detection Principle

The tip of the sensor incorporates a coil. Supplying this coil with a high-frequency current generates a high-frequency magnetic field. Moving a semiconductor close to this magnetic field generates an eddy current, and the impedance changes proportionately to the distance. The change in output is extracted using an LC resonance circuit created by combining the coil (L) and a condenser (C). The relationship between displacement and voltage is determined after high-frequency detection and linearizing processes.



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Chassis Parallelness/Warping Measurement

In the event there are any distortions in the chassis, the distance between the chassis and the sensors will change, enabling this to be detected to eliminate defective items.



Measuring Height of Large Vertical Lathe Table

Hydraulic pressure is applied to the table support surface to float it, and the table is rotated. It is checked at this time for any change in height.



Detection of ATC Chucking Failure

Improper chucking due to the entrance of chips or other foreign matter when the tool shank is inserted can be detected from runout of the shank flange.



Piston Head Concave Height Measurement

The combustion chamber volume can be checked by measuring the concave portion of the piston. An iron-measuring jig is mounted in front of the sensor, and the volume is measured from the movement distance of the jig when it comes into contact with the piston head.



Metal Press Monitoring

By measuring displacement during stamping on a press, it can be monitored to check for defective stamping, stamping scrap or fluctuations in material, and stopped in this event.



Detection of Run-Out Due to Improper Chucking

The parallelness of the workpiece is lost in the event foreign matter gets inside when the workpiece to be machined is chucked. Runout when the workpiece is rotated at this time can be detected.





Outer Appearance/Dimension Diagram



Specification

Specifications								
Model	Amplifier unit	E-ED-01						
Model	Sensor head	E-DT-ED03A E-DT-ED04			E-DT-ED05A			
Sensor head shape		Not shielded	Not shielded		Not shielded			
		ϕ 10 spherical surface	ϕ 15 spherical surface	•	ϕ 26 spherical surface			
		M12 mount M18 mount			M18 mount			
Main amplifier dimer	isions	$110(W) \times 51(H) \times 180$ (D) (Max. dimensions including rubber feet and sensor connector)						
Measuring length		0.05 – 2 mm	0.1 – 4 mm	1 – 8 mm				
Analog output	Response frequency		10 kHz (–3dB)					
	Linearity		$\pm0.5\%$ F.S.					
	Output voltage	+0.125 – +5V	+0.125 - +5V		+0.625 - +5V			
	Resolution		0.3 % F.S. *1					
Temperature	Amplifier unit	0.075 % F.S. / °C						
characteristics Sensor head		0.05 % F.S. / °C	0.05 % F.S. / °C		0.05 % F.S. / °C			
Power source	Voltage	DC 24 V ± 10%, Allowable ripple: 10% p-p or less						
	Consumption	200 mA or less						
Usage ambient Amplifier unit		0 – 40°C						
temperature	Sensor head	0 – 40°C						
Usage ambient	Amplifier unit	35 – 80 % R.H. (no condensation)						
humidity Sensor head		35 – 80 % R.H. (no condensation)						
Display LED		Power (PWR: Yellow), Detection distance (20, 40, 60, 80, 100%: Green, Over: Red)						
Protective structure	(sensor head)	IP67						
Sensor cable length		3m						
Weight Amplifier unit Sensor head (including cable)		Approx. 630 g						
		Approx. 110 g	Approx. 110 g Approx. 175 g		Approx. 210 g			
*: Above specifications are f	or when the item measured is the	e standard specimen.	standard specimen.					
*: % F.S. is percentage of measuring length upper limit value *: Resolution is the value when the specimen is stainless ste		el.	Model		E-DL-02			
*: Temperature characteristie *1: Excluding switching poise	cs are value when specimen is s e (Frequency component 250 kH	tainless steel and output voltage is 50 % F.S. z or higher)	Power source	AC100	V			
			Dimensions	110 //	· () × 150(D) × 45 (H) mm			
			Sinchalona	110 (W	/ × 150(D) × 45 (Π) IIIII			

ACCRETECH TOKYO SEIMITSU

Usage Guidelines

- The amplifier unit and sensor head units are adjusted in a one-to-one configuration. The precision cannot be guaranteed if this configuration is changed.
- Mount the sensor head unit so that the measuring surface is parallel with the surface to be measured.
- In order to achieve good measurement precision, the tip of the head unit must be separated from the object to be measured by a distance at least three times the diameter of the tip.
- The power input (+5V) for the amplifier unit is to be provided by the customer, or a separate power unit needs to be ordered.
- Use the unit in a location that has a minimum of ambient temperature fluctuation.
- Avoid subjecting the sensor head unit to shock or undue force. Take precautions to ensure that the sensor head unit is not scratched.
- The measuring sensitivity and linearity differ depending upon the material that is measured. The amplifier unit must be adjusted for each type of metal.

PULCOM >>>

PULCOM opto 30A/60B

Non-Contact Laser Outer Diameter Measuring Instruments



Features

Multi-Point/Multi-Item Measurement

Simultaneous measurement and judgment of four items at two locations can be performed.

Ideal for Centerless Grinder

The edge of the workpiece that is continuously fed is automatically detected, facilitating automatic control of the measurement timing.

Quick Response / High Precision

The provision of an 18-surface polygon scanner enables 1,500 scans to be performed per second, achieving high-precision measurements in a very short time.

Error Removal Filter

The provision of a dedicated digital signal processor-based error removal filter enables data errors due to water drops, foreign matter or scratches on the workpiece to be removed, enhancing data precision.

Principle

The laser beam emitted from the semiconductor laser is scanned by the polygon scanner and converted into parallel scanning light by the f θ lens after it is reflected by the reflection mirror.

This light is condensed after the workpiece is scanned and converted into an electrical signal. The workpiece diameter is calculated by measuring the dark time.



Specifications							
Set Model		Opto 30A-600	Opto 60B-600				
Model Measuring unit		E-LH-S30A	E-LH-S60B				
	Control unit	E-LC-S600					
Measuring rai	nge	0.3 – 30 mm	0.6 – 60 mm				
Light source		Red semiconductor laser (670 nm)					
Number of las	ser scans	1,500 times/second					
Laser scannir	ng rate	100 m/s	200 m/s				
Min. display v	value	Select: 0.01 μm, 0.1 μm or 1 μm					
Input/output c	onnector	Control I/O (Select individual judgment output or					
(including opt	ions)	BCD output), RS232C, analog output					
Pass/fail judgm	ent signal	Max. 20 ranks					
Number of measu	iring heads	1					
Usage temperat	ure range	0 – 40°C					
Usage humid	ity range	90% or less					
Power source	•	AC 85 – 250 V, 50/60 Hz					
Power consu	mption	25 VA					
Weight	Measuring unit	3.2 kg 5.5 kg					
	Control unit	4.5 kg					



ACCRETECH TOKYO SEIMITSU

Measurement of Drug Capsule Diameter/Length

The diameter and length of drug capsules can be measured with the PULCOM opto and a dedicated jig if the capsule is manually repositioned. Measurement can also be performed by changing the orientation of the jig.



Belt Width Detection

Belt width can be detected by the difference in interrupted light. Deviations to the right and left can be ignored by setting two sensors and using X+Y calculation.



Piston Outer Diameter Measurement

Piston outer diameter can be measured on a submicron level. Since the measuring unit is separate, measurements can be performed without interrupting line flow.



Measurement of Clearance Between Roller/Standard Blade

The clearance between a roller and standard blade can be measured on a sub-micron level. Measurements are highly precise and free from fluctuation due to the adoption of automatic measurement.



Electric Wire Outer Diameter Measurement (Simultaneous measurement of X/Y axes) Simultaneous measurement the outer diameter of electric wire from the X and Y axes enables the average outer diameter to be obtained.

Laser Light

Safety precautions have been implemented on this unit in accordance with JIS standards. The amount of output is low, but make sure to follow the instructions on the label to prevent injury.



Outer Appearance/Dimension Diagram



Usage Guidelines

- Do not operate the instrument when the measuring unit or control unit is not in proper operating condition. This includes all cases when the Ready signal is Off.
- Placing a heavy object on the control unit cover or subjecting it to a large force may result in deformation. Do not get on the control unit cover or place your foot on it.
- For safety purposes, make sure to properly connect the power ground wire and ground wires for each unit. If the ground wires are not connected, it may result in a malfunction of the machine or injury to personnel.
- Avoid subjecting the unit to shock. Take precautions to ensure that the unit is not subjected to undue shock or dropped as this may result in a breakdown.
- Handle the cable with care. Route the cable from the measuring head so that it will not be

smashed or damaged by chips or other moving objects. Secure the cable so that it will not be pulled or rub against parts when the head moves. The cable should be 200mm or more away from other power supplies and routed through a separate duct.

- Do not open the measuring head cover or other parts under any circumstances. Do not loosen or rotate any clamp screws, adjustment screws or other screws unless following specific instructions.
- Consult with ACCRETECH in advance before taking the unit to a different country to ensure compliance with applicable regulations and laws. The unit should not be taken out of the country in which it is sold without consulting with ACCRETECH. We cannot be responsible for any problems when it is taken to a different country without advance notice.